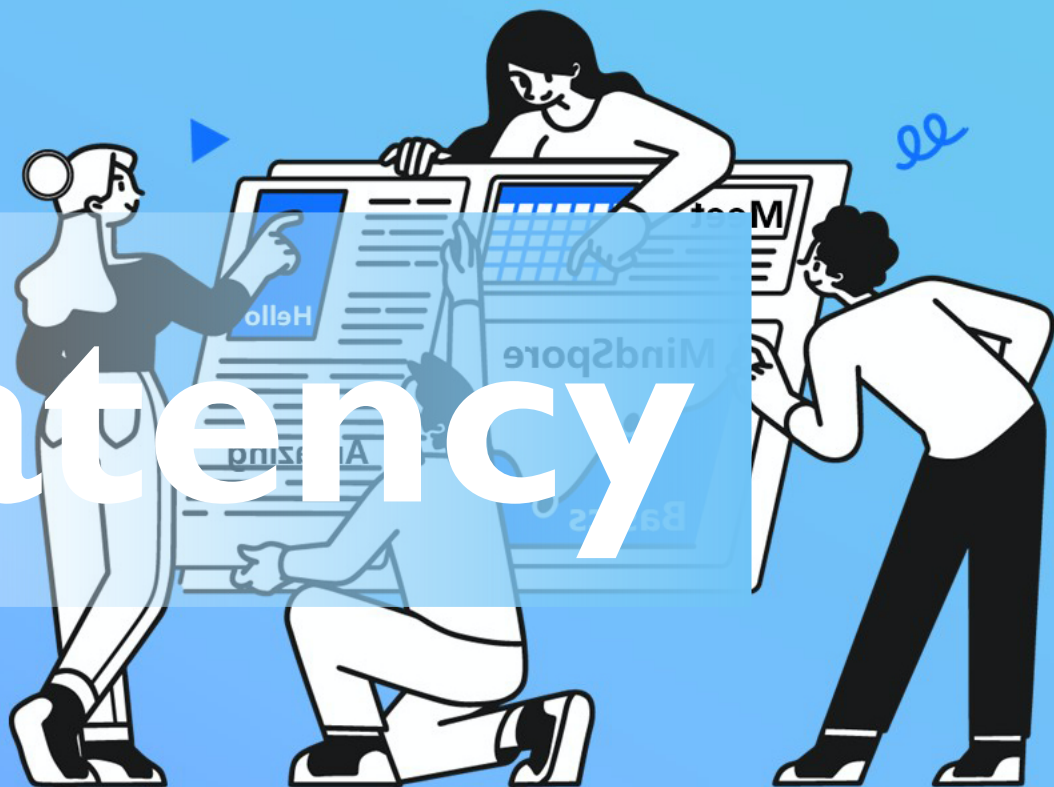


AI 芯片 – AI 芯片基础

计算时延 Latency



ZOMI

Talk Overview

1. AI 计算体系

- 深度学习计算模式
- 计算体系与矩阵运算

2. AI 芯片基础

- 通用处理器 CPU
- 从数据看 CPU 计算
- 通用图形处理器 GPU
- AI专用处理器 NPU/TPU
- 计算体系架构的黄金10年

计算强度

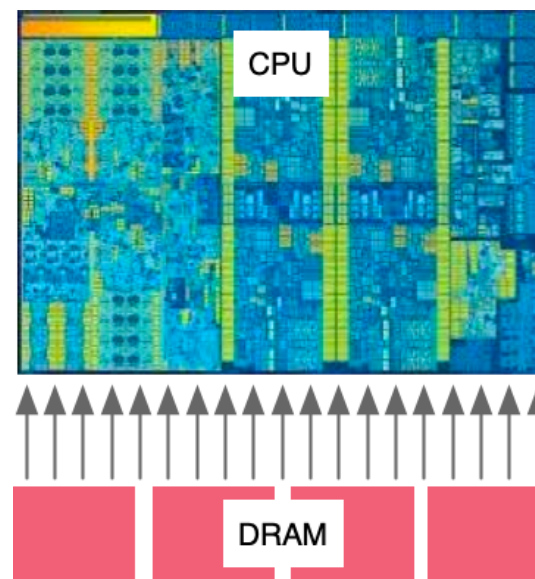
How many operations must I do on some data to make it worth the cost of loading it?

$$\text{Required Compute Intensity} = \frac{\text{FLOPs}}{\text{Data Rate}} = 80$$

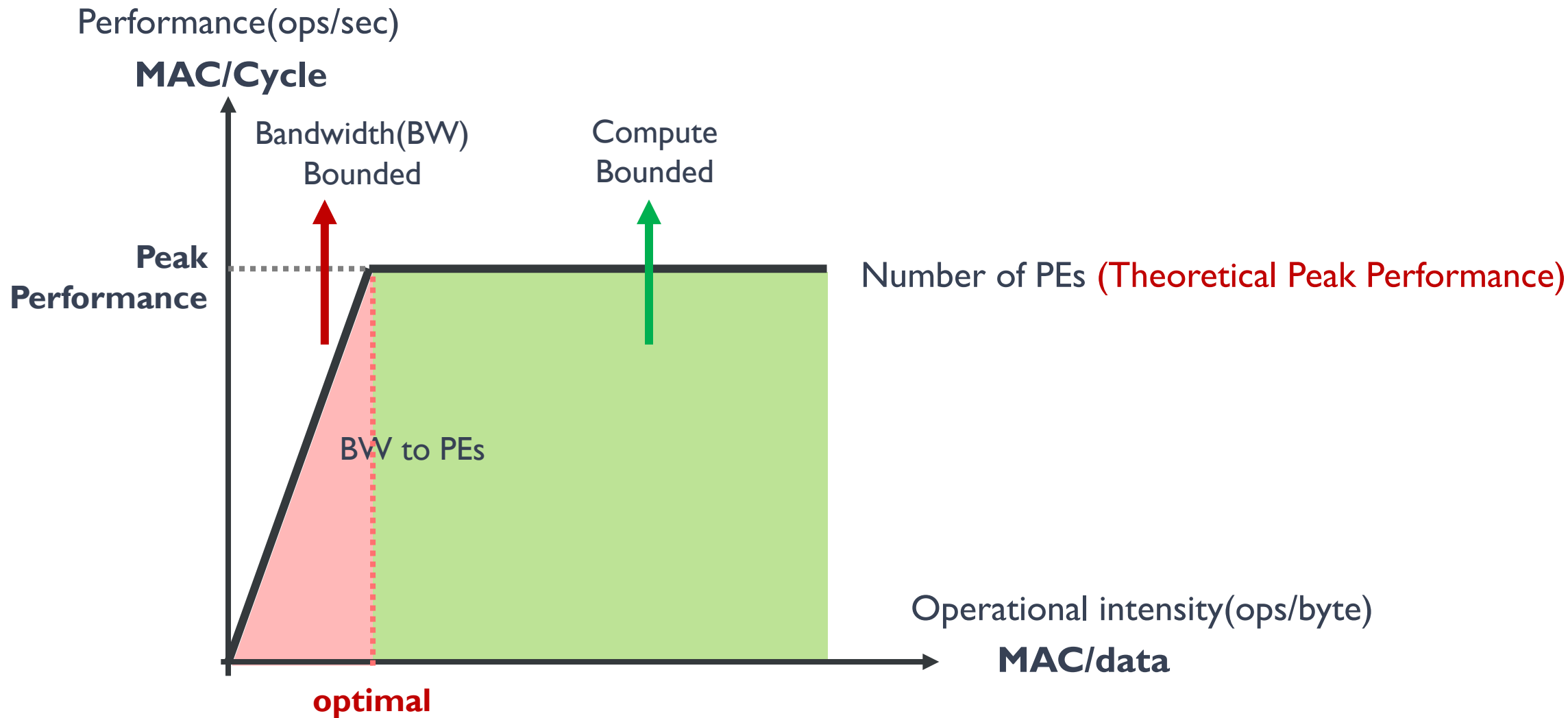
2000 GFLOPs FP64



200 GBytes / sec
= 25 Giga-FP64 / sec
(FP64 = 8 bytes)



So for every number load from memory, Need to do 80 Operations on it to break even.



更应该关注

内存、带宽 >> 时延

DAXPY 计算 DEMO

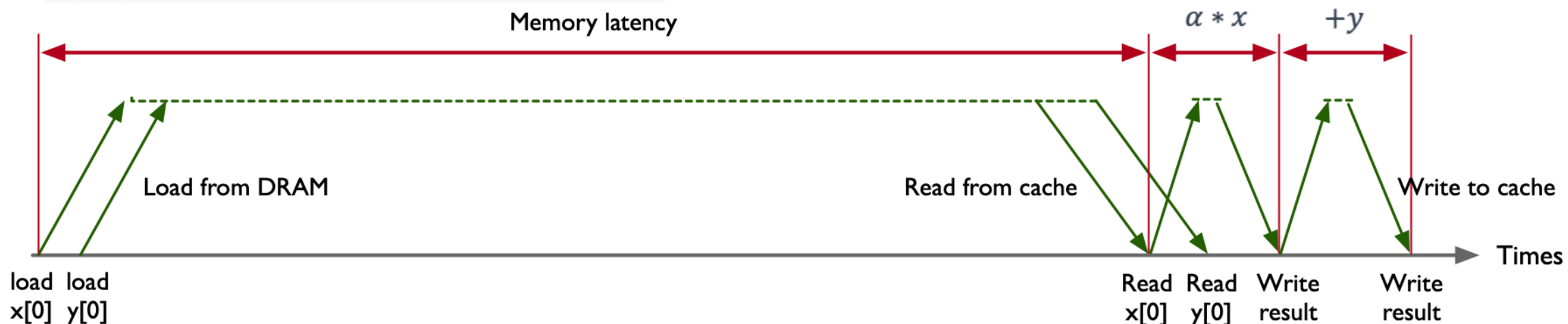
- 2FLOPs : multiply & add
- 2 Memory Loads: x[i] & y[i] (per element)
- Single Operation: FMA(fused multiply-add)

```
void demo(double alpha, double *x, double *y)
{
    int n = 2000;
    for(int i = 0; i < n; ++i)
    {
        y[i] = alpha * x[i] + y[i];
    }
}
```

DAXPY 计算 DEMO

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{
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光与电的传播速度

Speed of Light = 300,000,000 M/S

Computer Clock = 3,000,000,000 Hz

所以在—一个时钟周期内光的传播速度为 100mm (~4 inches)

光与电的传播速度

Speed of Light = 300,000,000 M/S

Computer Clock = 3,000,000,000 Hz

Speed of Electricity = 60,000,000 M/S

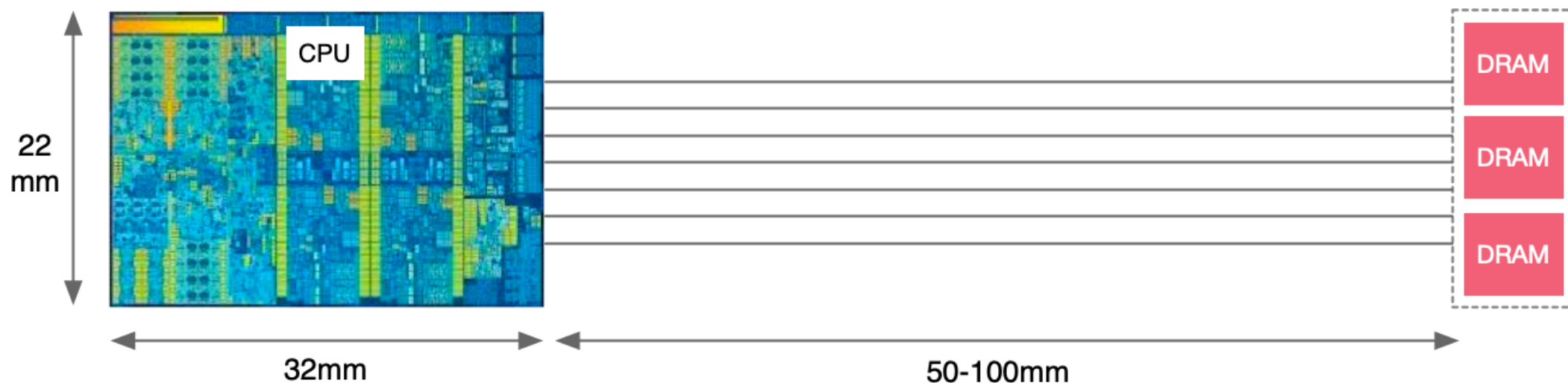
所以在—一个时钟周期电流的传播速度为 20mm (~0.8 inches)

光与电的传播速度

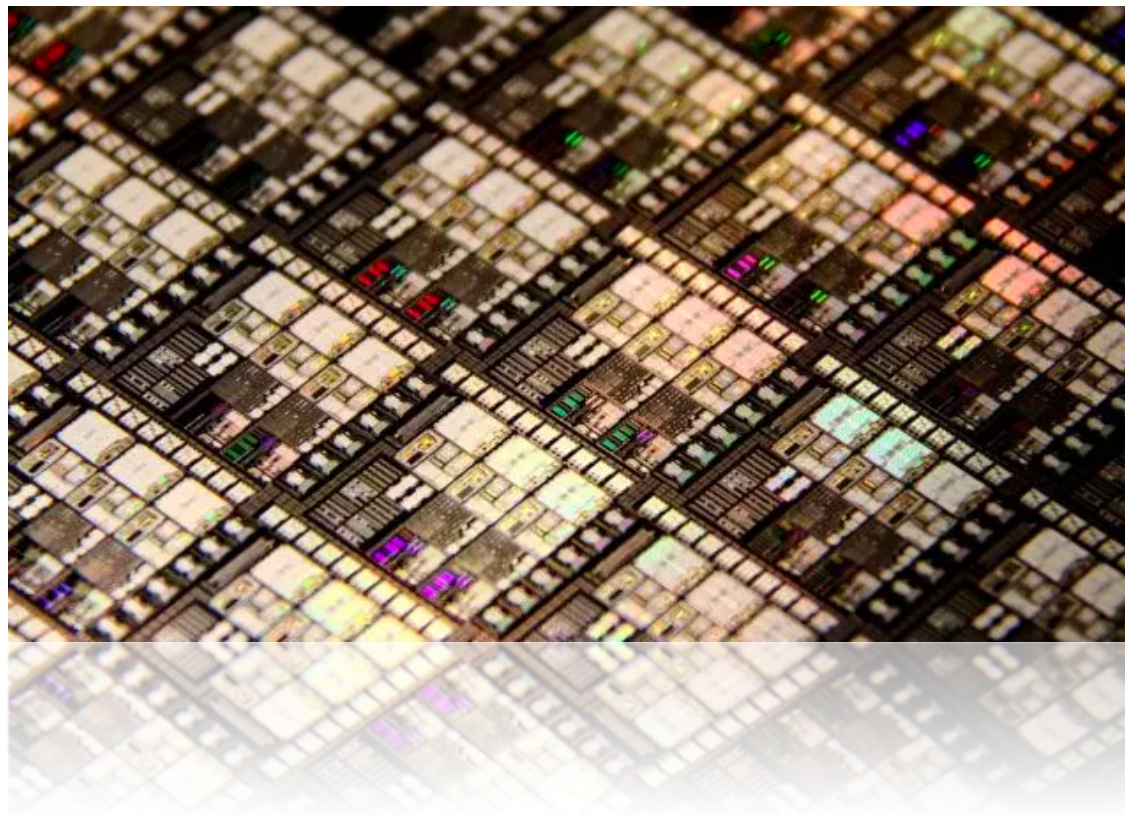
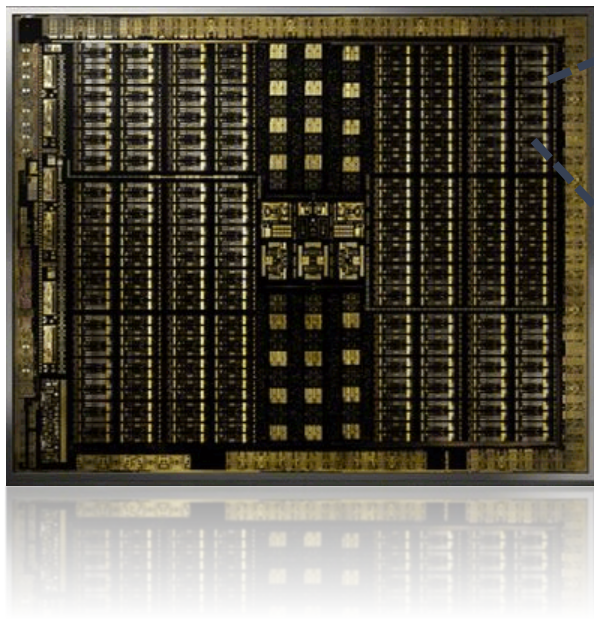
Speed of Light = 300,000,000 M/S

Computer Clock = 3,000,000,000 Hz

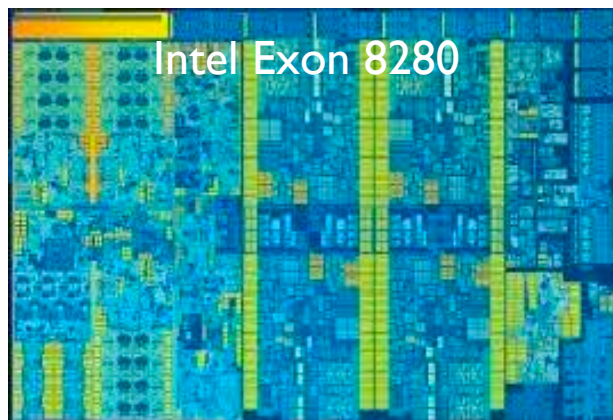
Speed of Electricity = 60,000,000 M/S



处理器内部



DAXPY 计算 DEMO



Memory Bandwidth: **131** GB/sec

Memory latency: **89** ns



11,659 bytes can be moved in **89** ns

AXY demo move **16 bytes per 89 ns** latency

Memory efficiency = **0.14%**

DAXPY 计算 DEMO



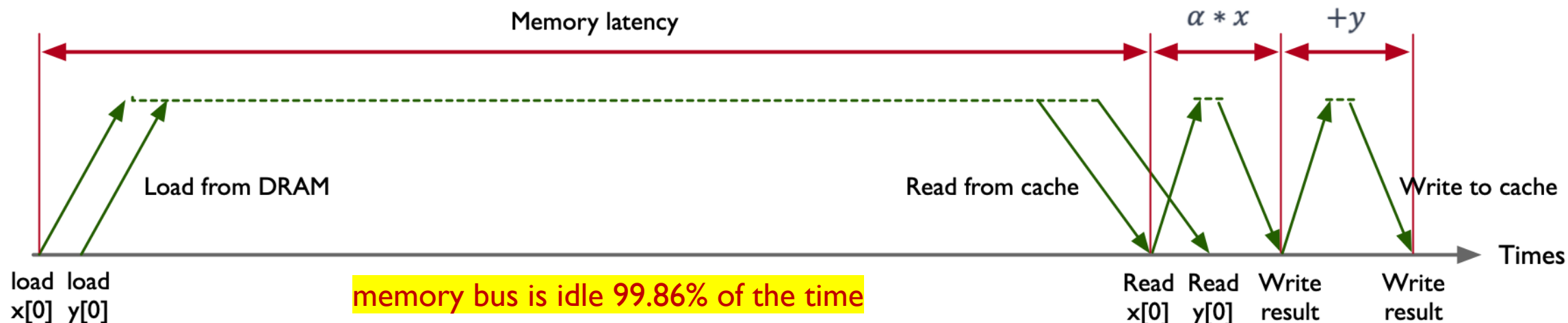
Memory Bandwidth: 131 GB/sec

Memory latency: 89 ns

} 11,659 bytes can be moved in 89 ns

AXY demo move 16 bytes per 89 ns latency

Memory efficiency = 0.14%



不同芯片产品的计算性能

	AMD Rome 7742	Intel Xeon 8280	NVIDIA A100
Memory B/W(GB/sec)	204	131	1555
DRAM Latency(ns)	122	89	404
Peak bytes per latency	24,888	11,659	628,220
Memory Efficiency	0.064%	0.14%	0.0025%

引用

1. <https://www.youtube.com/watch?v=3jHi8E5C-I8>
2. <https://www.youtube.com/watch?v=-P28LKWTzrl>
3. <https://www.youtube.com/watch?v=3II0o0DYJXg>





BUILDING A BETTER CONNECTED WORLD

THANK YOU

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